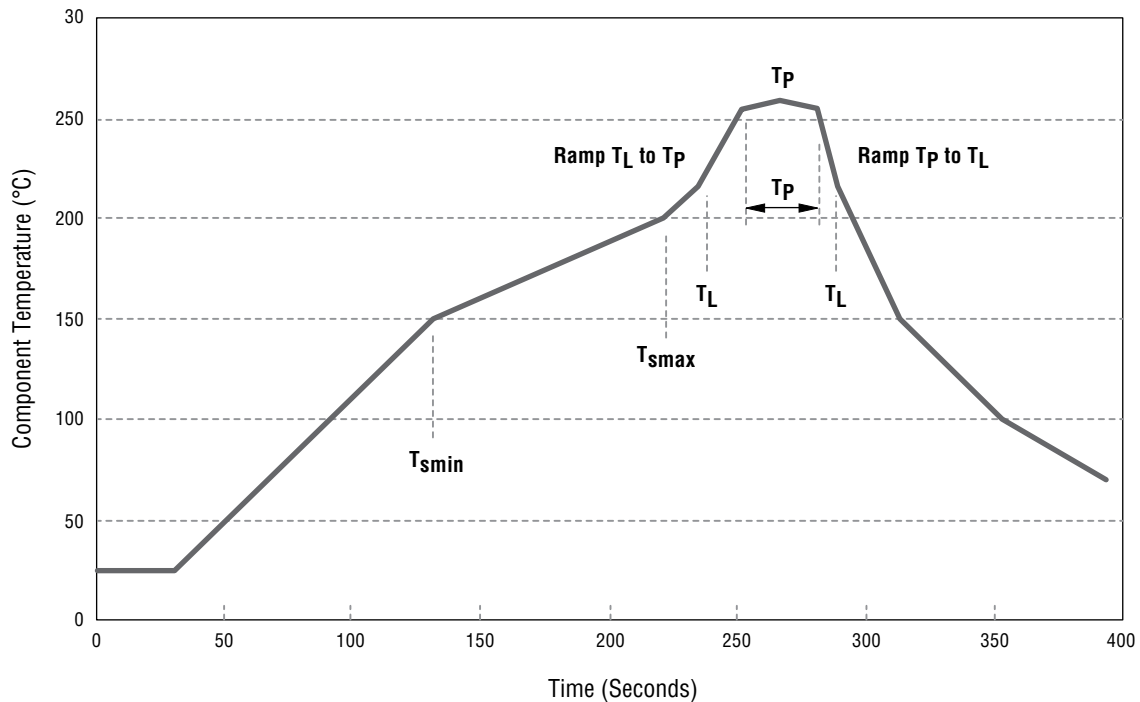


Pb Free Reflow Profile Recommendation (IPC/JEDEC J-STD-020E)

Reflow Parameter	Pb Free Assembly
Preheat <ul style="list-style-type: none"> - Temperature Min. (T_{Smin}) - Temperature Max. (T_{Smax}) - Time (t_{Smin} to t_{Smax}) 	150 °C 200 °C 60-120 seconds
Average Ramp Rate (T_{Smax} to T_P)	3 °C/second max.
Time Maintained Above <ul style="list-style-type: none"> - Temperature (T_L) - Time (t_L) 	217 °C 60-150 seconds
Peak Temperature (T_P)	260 °C +0/-5 °C
Time within 5 °C of Actual Peak Temperature (T_P)	30 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

IR / Convection Reflow Profile (IPC/JEDEC J-STD-020E)



Specifications are subject to change without notice.
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
 Users should verify actual device performance in their specific applications.